

Filename: PMP6857A_BOM_bom.xls						
Date: 08/18/2011						
PMP6857A_BOM BOM						
COUNT	RefDes	Value	Description	Size	Part Number	MFR
1	C11	1uF	Capacitor, Ceramic, 16V, X7R, 10%	0603	Std	Std
1	C12	4.7uF	Capacitor, Ceramic, 10V, X5R, 20%	0603	Std	Std
10	C1-5 C26-30	22uF	Capacitor, Ceramic, 25V, X5R, 20%	1210	Std	Std
2	C15-16	0.047uF	Capacitor, Ceramic, 25V, X7R, 10%	0402	Std	Std
2	C17 C20	1000pF	Capacitor, Ceramic, 25V, X7R, 10%	0402	Std	Std
2	C19 C22	22pF	Capacitor, Ceramic, 25V, X7R, 10%	0402	Std	Std
2	C21 C18	3300pF	Capacitor, Ceramic, 25V, X7R, 10%	0402	Std	Std
2	C31-32	Open	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std
6	C6-8 C23-25	330uF	Capacitor, Aluminum, SMT, 6.3V, 9mohm, 3Arms	7343(D)	6TPF330M9L	Sanyo
4	C9-10 C13-14	0.1uF	Capacitor, Ceramic, 16V, X7R, 10%	0402	Std	Std
1	J1	ED120/2DS	Terminal Block, 2-pin, 15-A, 5.1mm	0.40 x 0.35 inch	ED120/2DS	OST
6	J2-7	CX35-36-CY	Lug, Solderless, #10 - #10-12 AWG , Copper/Tin, Uninsulated	0.375 x1.00 inch	CX35-36-CY	Std
2	L1-2	1.5uH	Inductor, High Current, 31A, 1.3mohm	0.675 x 0.675 inch	IHLP6767GZER1R5M01	Vishay
2	Q1-2	CSD87353	MOSFET, Dual N-Chan, 30-V, 30-A, High Duty Cycle	QFN-8 POWER	CSD87353	TI
2	R11 R23	8.87K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
1	R12	66.5K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
2	R1-2	0	Resistor, Chip, 1/16W, 1%	0402	Std	Std
2	R13 R18	49.9	Resistor, Chip, 1/16W, 1%	0402	Std	Std
2	R15 R20	3.01K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
1	R16	2.87K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
4	R17 R14 R19 R22	20.0K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
1	R21	4.42K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
2	R24-25	Open	Resistor, Metal Film, 1/4 watt, ± 5%	1206	Std	Std
3	R3 R7 R9	10.0K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
2	R4 R8	Open	Resistor, Chip, 1/16W, 1%	0402	Std	Std
2	R5 R10	90.9K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
1	R6	1.82K	Resistor, Chip, 1/16W, 1%	0402	Std	Std
7	TP1-7	5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
4	TP8-11	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
1	U1	TPS40322RHB	IC, Dual Synchronous Buck Controller	QFN-32	TPS40322RHB	TI

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Mobile Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Transportation and Automotive	www.ti.com/automotive
Video and Imaging	www.ti.com/video

TI E2E Community Home Page

e2e.ti.com

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2011, Texas Instruments Incorporated